Specification of Thermoelectric Module

TES1-06325

Description

The 63 couples, 30mmx15mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70°C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

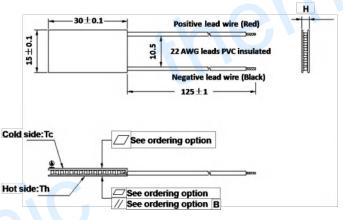
Performance Specification Sheet

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

| Th (°C) | 27 | 50 | Hot side temperature at environment: dry air, N ₂ | |
|----------------------------|------|------|-----------------------------------------------------------------------------------------------------------|--|
| DT _{max} (°C) | 70 | 79 | Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side | |
| U _{max} (Voltage) | 8.0 | 8.4 | Voltage applied to the module at DT _{max} | |
| I _{max} (Amps) | 2.8 | 2.8 | DC current through the modules at DT _{max} | |
| Q _{Cmax} (Watts) | 13.8 | 15.3 | Cooling capacity at cold side of the module under DT=0 °C | |
| AC resistance (Ohms) | 2.15 | 2.31 | The module resistance is tested under AC | |
| Tolerance (%) | ± 10 | | For thermal and electricity parameters | |

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

| A. Solder: | B. Sealant: |
|---------------------------------------------------------|-----------------------------------|
| 1. T100: BiSn (Tmelt=138°C) | 1. NS: No sealing (Standard) |
| 2. T200: CuAgSn (Tmelt = 217°C) | 2. SS: Silicone sealant |
| 3. T240: SbSn (Tmelt = 240°C) | 3. EPS: Epoxy sealant |
| C. Ceramics: | D. Ceramics Surface Options: |
| | |
| 1. Alumina (Al ₂ O ₃ , white 96%) | 1. Blank ceramics (not metalized) |

Naming for the Module

AlO: Alumina, white 969

Ordering Option

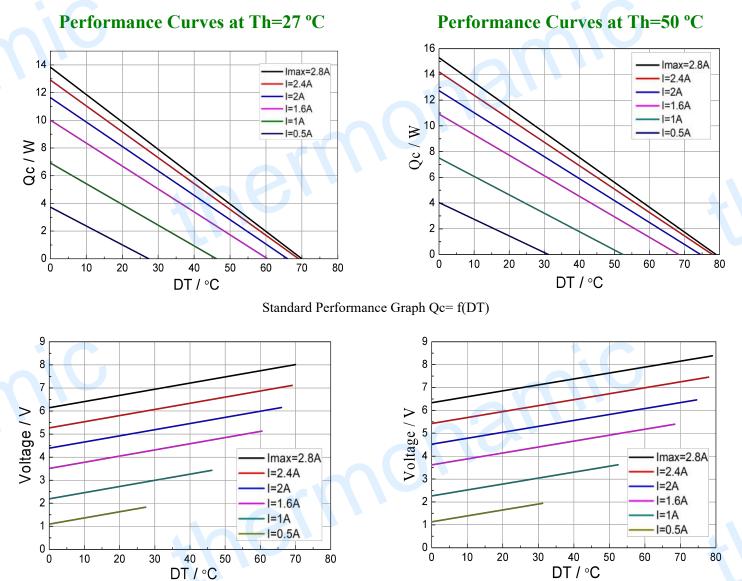
| Suffix | Thickness H (mm) | Flatness/ Parallelism (mm) | Lead wire length(mm) Standard/Optional length | TES1- 06325- X - X - X - X \Box \Box \Box Ceramics |
|-----------------------------------------------------------------|---------------------|-------------------------------|--------------------------------------------------|-------------------------------------------------------------|
| TF | 0:4.0± 0.1 | 0: 0.07/0.07 | 125±1/Specify | Flatness/ Parallelism |
| TF | $1:4.0 \pm 0.03$ | 1: 0.025/0.025 | 125±1/Specify | TES1- 06325–T100 -NS –TF01 -AlO |
| Eg. TF01: Thickness 4.0± 0.1 (mm) and Flatness 0.025/0.025 (mm) | | | | T100: BiSn (Tmelt=138°C) |

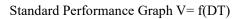
NS: No sealing

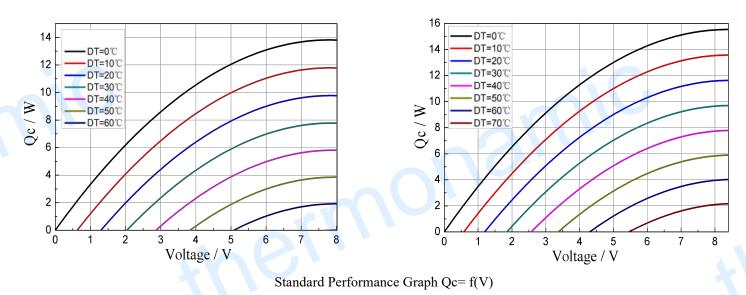
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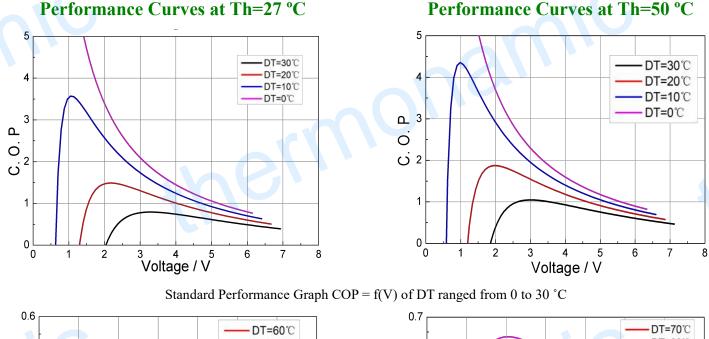


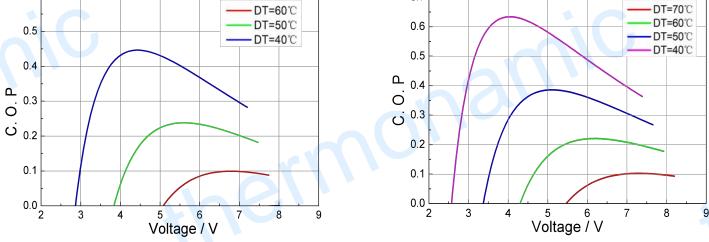


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Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Caution

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.